



Parameter	Rating	Units
Blocking Voltage	60	V _P
Load Current	120	mA
Max On-resistance	16	Ω
LED Current to operate	1	mA

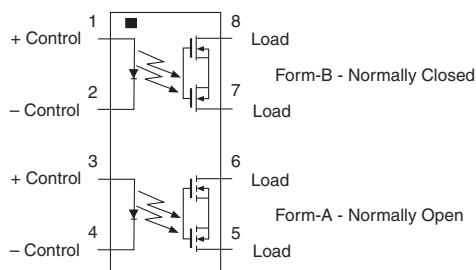
Features

- 1500V_{rms} Input/Output Isolation
- TTL/CMOS Compatible input
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Immune to radiated EM fields
- SMD Pick & Place, Wave Solderable
- Small 8-Pin SOIC Package
- Tape & Reel Version Available

Applications

- Security
 - Passive Infrared Detectors (PIR)
 - Data Signaling
 - Sensor Circuitry
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
- Medical Equipment—Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Pin Configuration



Description

The CPC2317N is a miniature device with one independent normally open (1-Form-A) solid state relay and one independent normally closed (1-Form-B) solid state relay in an 8-pin SOIC package. It uses Clare's patented, optically coupled, OptoMOS architecture to provide 1500V_{rms} of input/output isolation.

The relay outputs are constructed with efficient MOSFET switches and photovoltaic die that use Clare's patented OptoMOS architecture while the input, a highly efficient GaAlAs infrared LED, provides the optically coupled control.

CPC2317N uses Clare's state of the art, double-molded vertical construction packaging to produce one of the world's smallest relays. It is ideal for replacing larger, less-reliable reed and electromechanical relays.

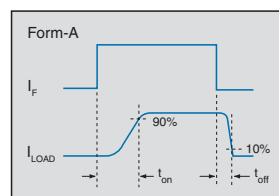
Approvals

- UL Certified Component: File E76270
- CSA Certified Component: Certificate 1172007
- EN/IEC 60950-1 Certified Component:
TUV Certificate B 10 05 49410 006

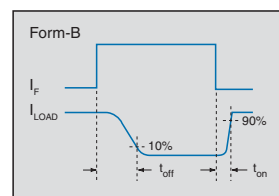
Ordering Information

Part #	Description
CPC2317N	8-Pin SOIC (50/tube)
CPC2317NTR	8-Pin SOIC (2000/reel)

Switching Characteristics of Normally Open (Form-A) Devices



Switching Characteristics of Normally Closed (Form-B) Devices



Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	60	V _P
Reverse Input Voltage	5	V
Input Control Current Peak (10ms)	50	mA
	1	A
Total Power Dissipation ¹	600	mW
Isolation Voltage, Input to Output	1500	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C
Soldering Temperature (10 Seconds)	260	°C

¹ Derate linearly 5mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

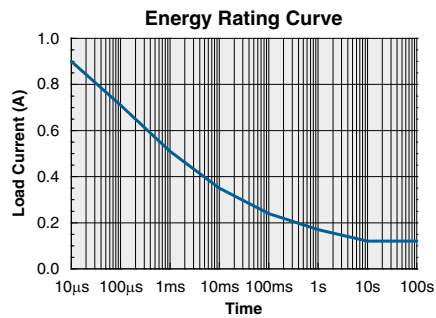
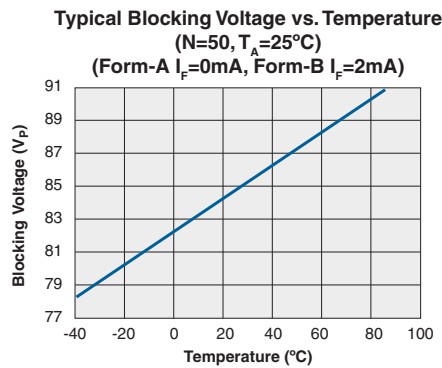
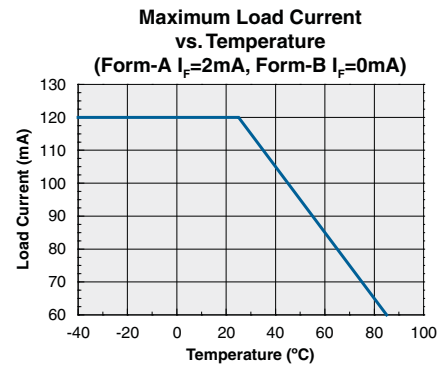
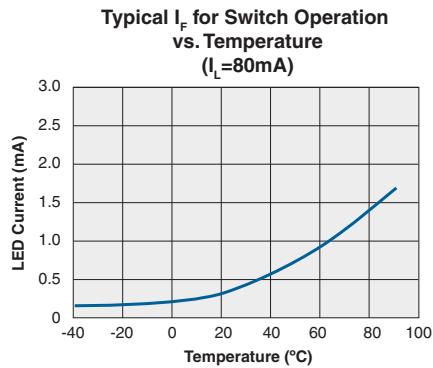
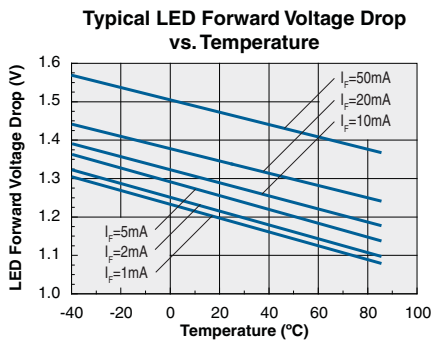
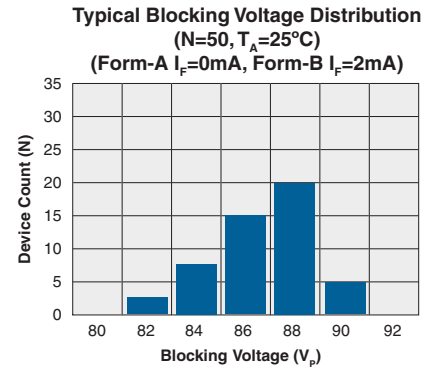
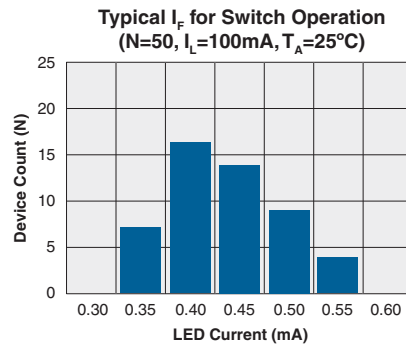
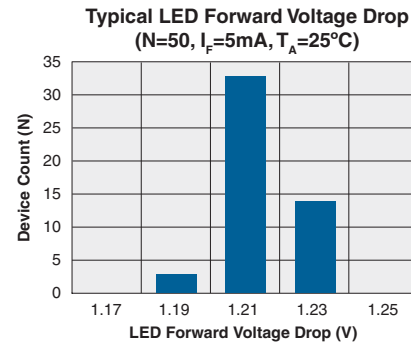
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current						
Normally Open (Form-A) Continuous ¹	I _F =1mA	I _L	-	-	120	mA
Normally Closed (Form-B) Continuous ¹	I _F =0mA					
Peak	t=10ms	I _L PK	-	-	350	mA _P
On-Resistance ²	I _L =120mA	R _{ON}	-	-	16	Ω
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	t _{on}	-	-	3	ms
Turn-Off		t _{off}	-	-	3	
Off-State Leakage Current	V _L =60V _P	I _{LEAK}	-	-	1	μA
Output Capacitance						
Normally Open (Form-A)	I _F =0mA, V _L =50V, f=1MHz	C _{OUT}	-	25	-	pF
Normally Closed (Form-B)	I _F =5mA, V _L =50V, f=1MHz					
Input Characteristics						
Input Control Current ³	I _L =100mA	I _F	-	0.40	1	mA
Input Dropout Current	-	I _F	0.1	0.35	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics						
Capacitance, Input to Output	-	-	-	1	-	pF

¹ Load current derates linearly from 120mA @ 25°C to 60mA @ 85°C, and must be derated for both poles operating simultaneously.

² Measurement taken within 1 second of on-time.

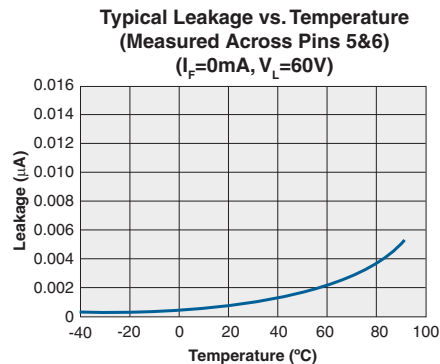
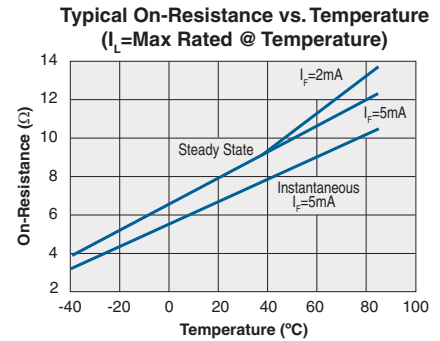
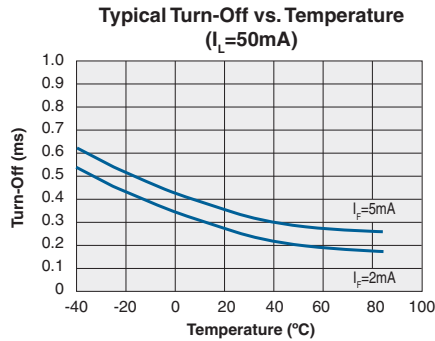
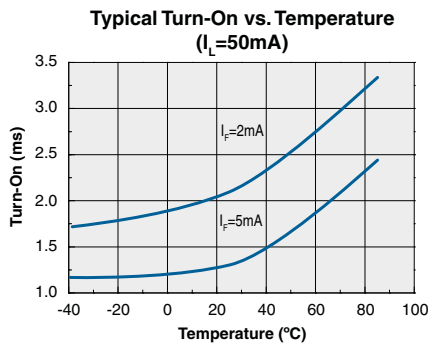
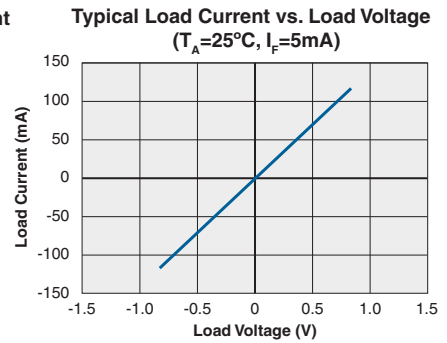
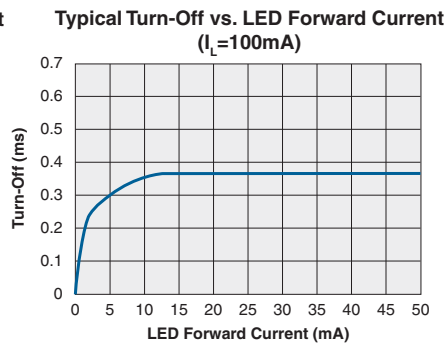
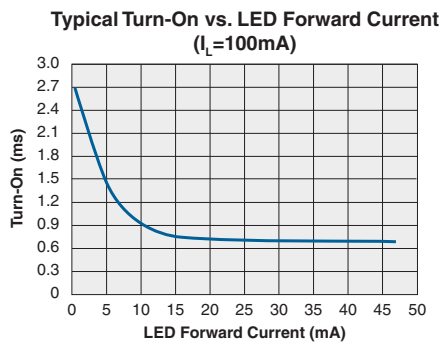
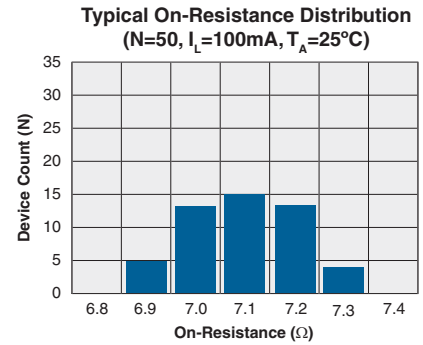
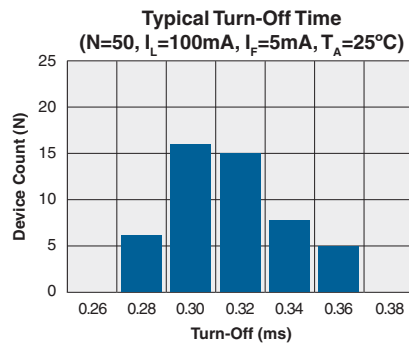
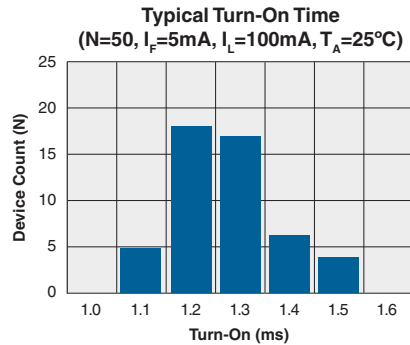
³ For applications requiring high temperature operation (greater than 60°C) a LED drive current of 3mA is recommended.

COMMON PERFORMANCE DATA*



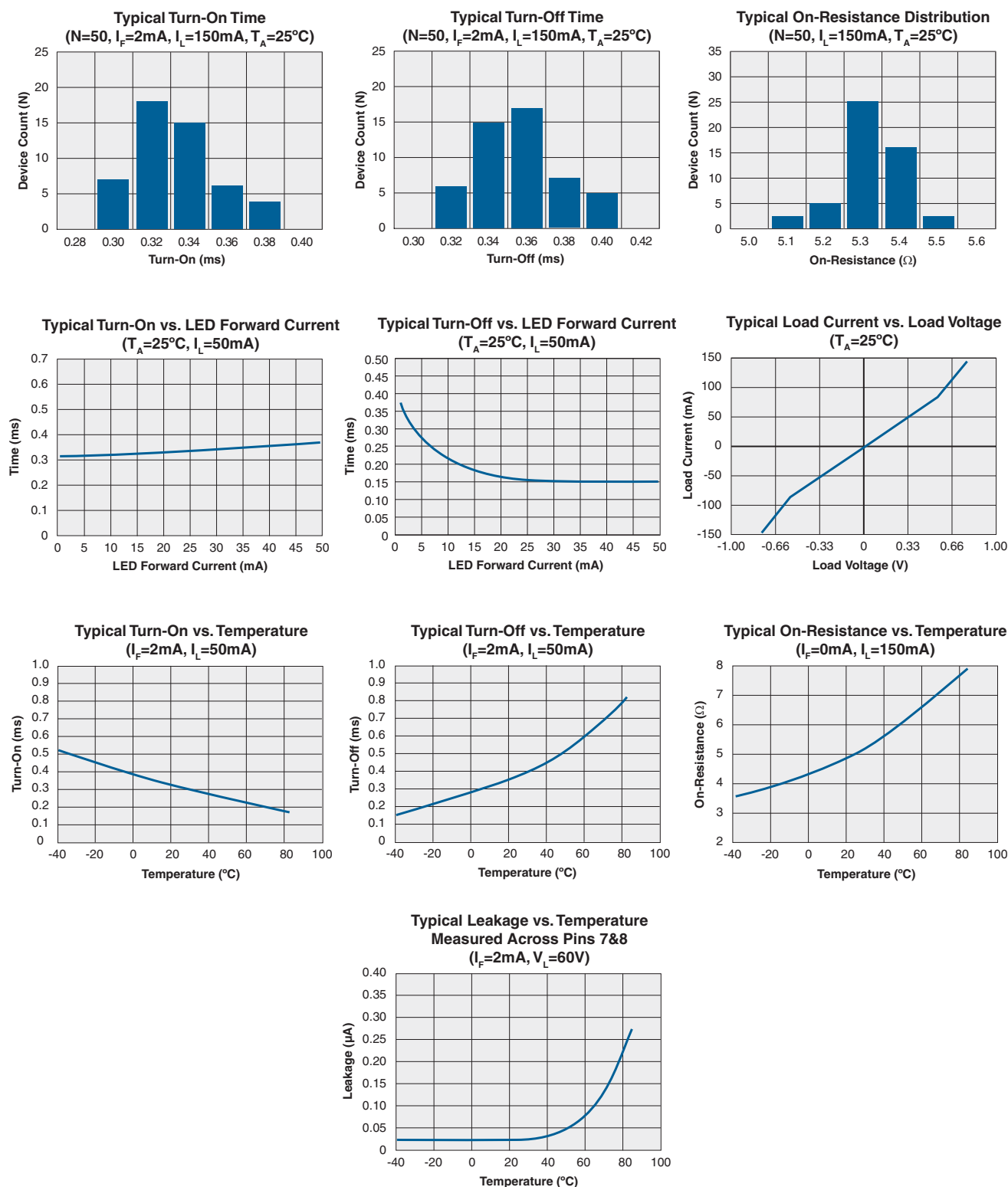
*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

FORM-A PERFORMANCE DATA*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

FORM-B PERFORMANCE DATA*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC2317N	MSL 3

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC2317N	260°C for 30 seconds

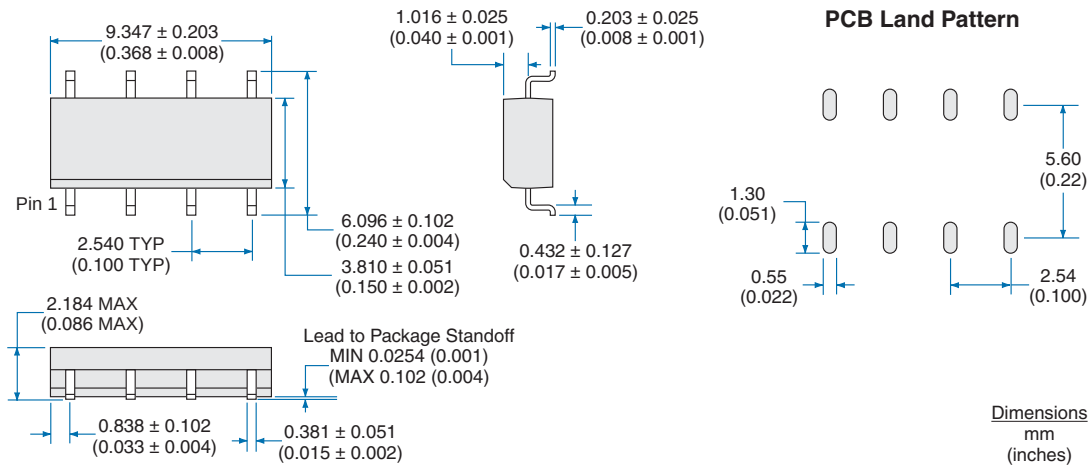
Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake may be necessary if a wash is used after solder reflow processes. Chlorine-based or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

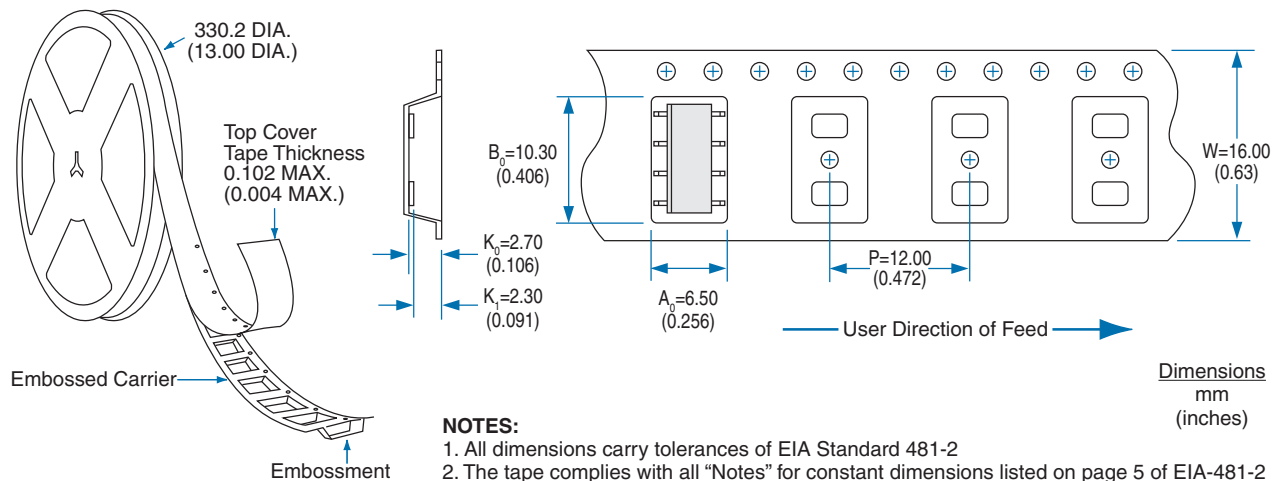


MECHANICAL DIMENSIONS

CPC2317N



CPC2317N Tape & Reel



For additional information please visit our website at: www.clare.com

Clare, Inc. makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in Clare's Standard Terms and Conditions of Sale, Clare, Inc. assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of Clare's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. Clare, Inc. reserves the right to discontinue or make changes to its products at any time without notice.

Specification: DS-CPC2317N-R02
©Copyright 2011, Clare, Inc.
OptoMOS® is a registered trademark of Clare, Inc.
All rights reserved. Printed in USA.
5/11/2011